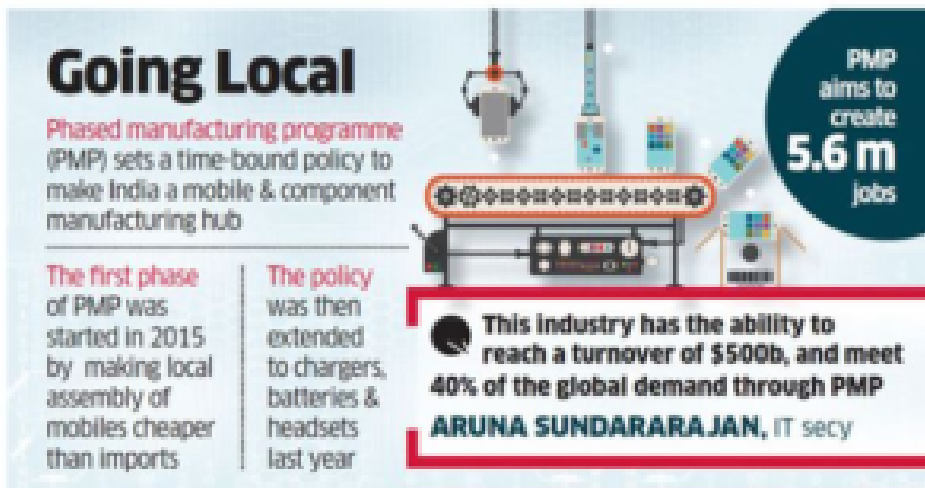


Phased Manufacturing Programme

February 12, 2021

About phased manufacturing programme (PMP)

- The PLI follows the phased manufacturing programme (PMP) which was launched in 2016-17.
- The PMP aimed to increase the share of locally-procured components in the manufacturing of mobile phones leading to the setting up of a “robust indigenous mobile manufacturing ecosystem in India.”
- The PMP incentivised the manufacture of low value accessories initially, and then moved on to the manufacture of higher value components.
- This was done by increasing the basic customs duty on the imports of these accessories or components.



Implementation status of Phased Manufacturing Programme (PMP) for cellular mobile handsets and sub-assemblies/ parts thereof

Year	Sub-Assembly
2016-17	(i) Charger/ Adapter, (ii) Battery Pack, (iii) Wired Headset – (Implemented: 15% BCD)

2017-18	(iv) Mechanics, (v) Die Cut Parts, (vi) Microphone and Receiver, (vii) Key Pad, (viii) USB Cable – (Implemented: 15% BCD)
2018-19	(ix) Printed Circuit Board Assembly (PCBA) – (Implemented: BCD increased to 20% w.e.f. 01.04.2020) (x) Camera Module, (xi) Connectors – (Implemented: 10% BCD)
2019-20	(xii) Display Assembly, (xiii) Touch Panel/ Cover Glass Assembly – (BCD deferred till 30.09.2020. It will be 10% w.e.f. 01.10.2020) (xiv) Vibrator Motor / Ringer – (Implemented: 10% BCD w.e.f. 01.04.2020)